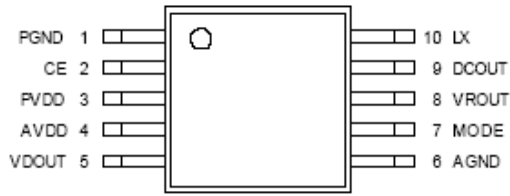
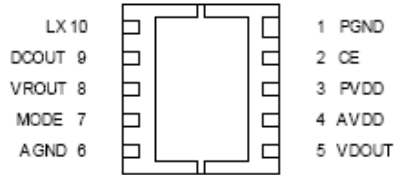


## ■ PIN CONFIGURATION

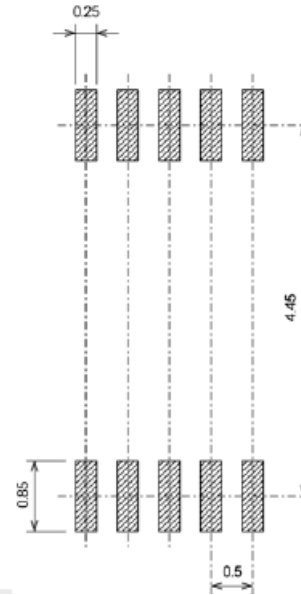


MSOP-10 (TOP VIEW)

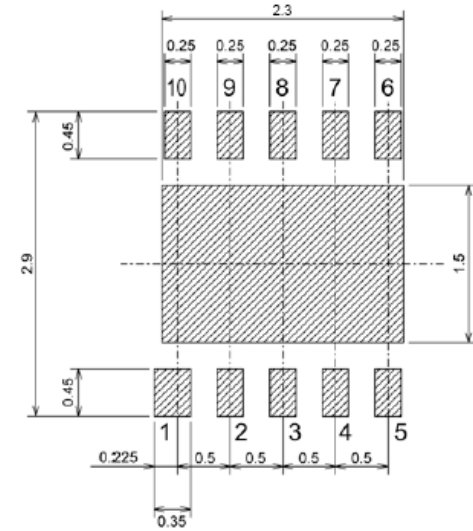


\*Please do not connect a heat dissipation pad to the circuitry. If the pad needs to be connected to other pins, it should be connected to the AGND pin.

## ● MSOP-10

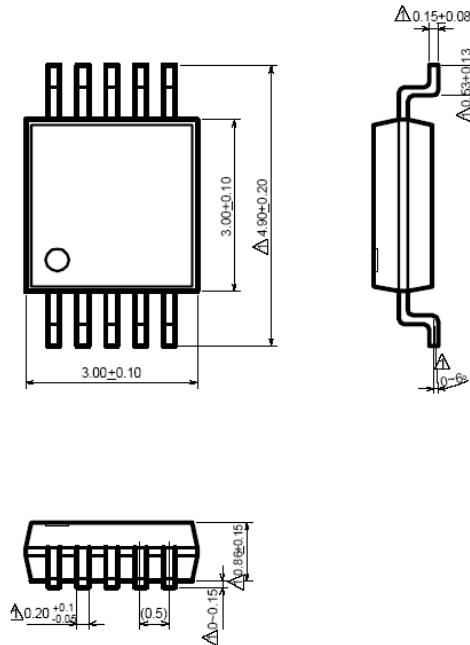


## ● USP-10

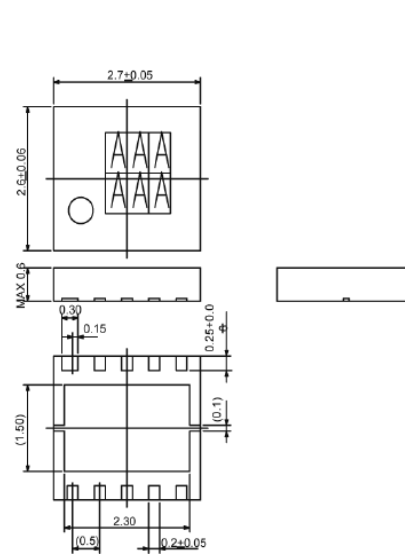


## ■ PACKAGING INFORMATION

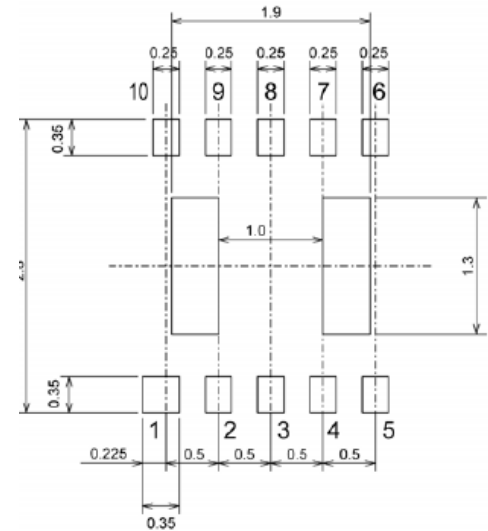
### ● MSOP-10



### ● USP-10



Note: Recommended metal design



\* Soldering fillet surface is not formed because the sides of the pins are not plated.